IPC ASSOCIATION CONNECT ELECTRONICS INDUSTR	© Copyright 2005. IP	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowel level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				Materials ar	ials and Mfg Information				
upplier Infor	mation														
Company name*			Company unique ID			J	Unique ID Authority				Res	Response Date*			
nsemi										202	2025-06-06				
Contact Name			Title - Contact			I	Phone - Contact*				Em	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance]	NA				Pro	Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			I	Phone - Representative*				Em	Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance			1	NA				Pro	Product-Env-Stewards@onsemi.com			
Reques	Requester Item Number M		Mfr Item Number Mfr Item Name				Effective Date	Versio	n	Manufacturing Site		Weight*	UOM	Unit Type	
		FSBB30CH60C SPM3V_V4 IN		SPM3V_V4 INV	600V 30A		2025-06-06			СРА		15260.756	mg	Each	
	g Process Informat								_						
8 · · · · · · · · · · · · · · · · · · ·				-STD-020 MSI	L Rating	Peak Process Body Temperature		İ	Γ'		r of Reflow Cy	cles			
Matte 1	Γin (Sn) - annealed		CU Alloy	N	VA.		0		C	30	S	econds 3			
omments															
r more informa	tion regarding material c	composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-En									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	67.7	mg	Supplier	Silicon (Si)	7440-21-3		67.7	mg
Die Attach	22.9498	mg	Supplier	Silver (Ag)	7440-22-4		0.5737	mg
			Supplier	Tin (Sn)	7440-31-5		21.2286	mg
			Supplier	Copper (Cu)	7440-50-8		1.1475	mg
Die Attach2	7.52661	mg	Supplier	Poly(oxypropylene)diamine	9046-10-0		0.2258	mg
			Supplier	Miscellaneous	Trade Secret		0.3763	mg
			Supplier	Silver (Ag)	7440-22-4		6.3976	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.5269	mg
Die Attach Solder	1.09661	mg	Supplier	Silver (Ag)	7440-22-4		0.0274	mg
			A	Lead (Pb)	7439-92-1	7a	1.0144	mg
			Supplier	Tin (Sn)	7440-31-5		0.0548	mg
Heat Sink	1880.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		676.8	mg
			Supplier	Copper (Cu)	7440-50-8		1203.2	mg
Lead Frame	3026.94	mg	Supplier	Silver (Ag)	7440-22-4		0.0303	mg
			Supplier	Iron (Fe)	7439-89-6		3.0269	mg
			Supplier	Copper (Cu)	7440-50-8		3022.9746	mg
			Supplier	Phosphorus (P)	7723-14-0		0.9081	mg
Mold Compound-Black	10122.0	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		303.66	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		2024.4	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		253.05	mg
			Supplier	Carbon Black (C)	1333-86-4		101.22	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		7439.6699	mg
Plating	113.724	mg	Supplier	Tin (Sn)	7440-31-5		113.724	mg
Wire Bond - Al	18.3	mg	Supplier	Aluminum (Al)	7429-90-5		18.3	mg
Wire Bond - Cu	0.519	mg	Supplier	Copper (Cu)	7440-50-8		0.519	mg